

PHOTO DIODE SILICON PIN LED LAMPS



LPD62343/A-PF

DATA SHEET

- DOC. NO : QW0905-LPD62343/A-PF
- REV. : <u>A</u>
- DATE : 31 Jul. 2014



LIGITEK

LIGITEK ELECTRONICS CO.,LTD. Property of Ligitek Only

PART NO. LPD62343/A-PF



The LPD62343/A-PF series are silicon planar P/N photodiodes incorporated in plastic package that simultaneously serve as filter and are also Transparent for infrared emission their terminals are soldering tabs arranged in 2.54mm center to center spacing due to their design the diodes can vertically be assembled on pc boards arrays can be realized by multiple arrangement versatile photodetectors are suitable for diodes as well as voltaic cell operation the signal noise ratio is particularly favorable even at low illuminance the P/N photodiode are outstanding for low junction capacitance high cut-off frequency and fast switching times. They are particularly suitable for IR sound transmission and remote control the cathode of LPD62343/A-PF photodiode is marked by a stamping on the package edge

Description

NOTE:1.All dimension are In millimeters tolerance Is ± 0.25 unless otherwise noted 2.Specifications are subject to change without notice

• MAXIMUM RATINGS (TA=25℃)

•		,,						
Characteristic		Symbol	Rating			∪nit		
Reverse Break Down Voltage		Vbr	30			V		
Power Dissipation		PD	150			mW		
Operating Temperature		Topr	-30 - +60			°C		
Storage Temperature		Tstg	-40 - +60			°C		
• ELECTRICAL CHARACTERISTICS AT (TA=25°C)								
Characteristic	Symbol	Test Condition	Min	Тур	Max	Unit		
Dark Current	lo	VR=10V Ee=0mW/cm ²	_	1.0	30	nA		
		V _{R=5} V λ P=940nm						

Dark Current	ID	VR=10V Ee=0mvv/cm	—	1.0	30	nA
Shart Circuit Current	lsc	VR=5V λ P=940nm	1.0	2.0	_	uA
Short Circuit Current		Ee=0.5mW/cm ^²	1.0			
Open Circuit Veltage	Voc	λ P=940nm		350	_	mV
Open Circuit Voltage		Ee=0.5mW/cm ^²	-			
Total Capacitance	Ст	VR=3V f=1MHZ Ee=0mW/cm²	_	20	_	pF
Peak Wavelength of Max Sensitivity	λ smax		_	940	_	nm
Rise Time,Fall Time	tr,tf	$VR=10V RL=1K\Omega$	_	50	_	ns
		·				

Page1/3



LIGITEK ELECTRONICS CO.,LTD. Property of Ligitek Only

PART NO. LPD62343/A-PF

Page 2/3

Soldering Condition(Pb-Free)

1.Iron:

Soldering Iron:30W Max Temperature 350°C Max Soldering Time:3 Seconds Max(One Time) Distance:2mm Min(From solder joint to body)

2.Wave Soldering Profile

Dip Soldering Preheat: 120°C Max Preheat time: 60seconds Max Ramp-up 2°C/sec(max) Ramp-Down:-5°C/sec(max) Solder Bath:260°C Max Dipping Time:3 seconds Max Distance:2mm Min(From solder joint to body)



Note:1.Wave solder should not be made more than one time.2.You can just only select one of the soldering conditions as above.



LIGITEK ELECTRONICS CO.,LTD. Property of Ligitek Only

PART NO. LPD62343/A-PF

Page 3/3

Reliability Test:

Test Item	Test Condition	Description	Reference Standard	
Operating Life Test	1.Under Room Temperature 2.If=20mA 3.t=1000 hrs (-24hrs, +72hrs)	This test is conducted for the purpose of detemining the resistance of a part in electrical and themal stressed.	MIL-STD-750: 1026 MIL-STD-883: 1005 JIS C 7021: B-1	
High Temperature Storage Test	1.Ta=105 ℃±5℃ 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under condition of high temperature for hours.	MIL-STD-883:1008 JIS C 7021: B-10	
Low Temperature Storage Test	1.Ta=-40 ℃±5℃ 2.t=1000 hrs (-24hrs, +72hrs)	The purpose of this is the resistance of the device which is laid under condition of low temperature for hours.	JIS C 7021: B-12	
High Temperature High Humidity Test	1.Ta=65 ℃±5℃ 2.RH=90 %~95% 3.t=240hrs ±2hrs	The purpose of this test is the resistance of the device under tropical for hours.	MIL-STD-202:103B JIS C 7021: B-11	
Thermal Shock Test	1.Ta=105 ℃±5℃ &-40℃±5℃ (10min) (10min) 2.total 10 cycles	The purpose of this is the resistance of the device to sudden extreme changes in high and low temperature.	MIL-STD-202: 107D MIL-STD-750: 1051 MIL-STD-883: 1011	
Solder Resistance Test	1.T.Sol=260 ℃±5℃ 2.Dwell time= 10 ±1sec.	This test intended to determine the thermal characteristic resistance of the device to sudden exposures at extreme changes in temperature when soldering the lead wire.	MIL-STD-202: 210A MIL-STD-750: 2031 JIS C 7021: A-1	
Solderability Test	1.T.Sol=245 ℃±5℃ 2.Dwell time=5 ±1sec	This test intended to see soldering well performed or not.	MIL-STD-202: 208D MIL-STD-750: 2026 MIL-STD-883: 2003 JIS C 7021: A-2	